TOUCH MODULE

WKS101WX003-WCT

Version:0.0 Jan 6, 2018

PRODUCT: TFT TOUCH MODULE

MODULE NO.: WKS101WX003-WCT

SUPPLIER: WKS Technology Co., LTD

DATE: Jan 6, 2018

WKS

SPECIFICATION

Revision: 0.0

WKS101WX003-WCT

This module uses ROHS material

This specification may change without prior notice in order to improve performance or quality. Please contact WKS R&D department for updated specification and product status before design for this product or release of this order.

WRITTEN BY	CHECKED BY	APPROVED BY
Jason	Eric	Henry

REVISION RECORD

REV NO.	REV DATE	CONTENTS	REMARKS
0.0	2018-01-6	First release	Preliminary

CONTENTS

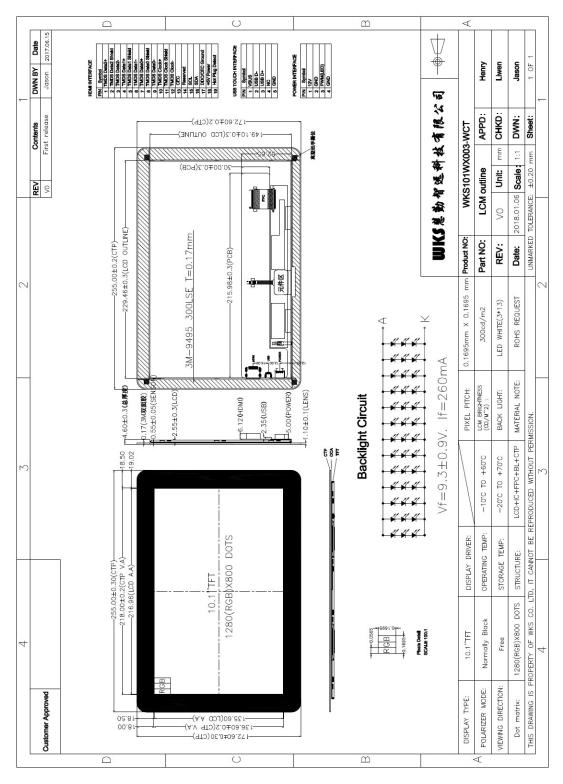
- 1, GENERAL INFORMATION
- 2, EXTERNAL DIMENSIONS
- 3. ABSOLUTE MAXIMUM RATINGS
- 4. ELECTRICAL CHARACTERISTICS
- 5, CTP CHARACTERISTICS
- 6 LECTRO-OPTICAL CHARACTERISTICS
- 7, INTERFACE DESCRIPTION
- 8, INPUT TIMING
- 9, RELIABILITY TEST CONDITIONS
- 10 SINSPECTION CRITERION
- 11 PRODUCT PHOTOS



1. GENERAL INFORMATION

Item of general information		Contents	Unit
LCD Display Size (Diagonal)		10.1	inch
Module Structure	LCD Displa	y + CTP Touch + PCB	-
LCD Display Type	TFT/	TRANSMISSIVE	-
LCD Display Mode	No	-	
Recommended Viewing Direction		-	
Gray inversion Direction		-	
Module size $(W \times H \times T)$	255.00×172.60×4.60		mm
Active area (W×H)	21	mm	
Number of pixels (Resolution)	12	pixel	
Pixel pitch (W×H)	0.	1695×0.1695	mm
Color Pixel Arrangement		RGB Stripe	-
	LCD Display	HDMI interface	-
Module Interface Type	СТР	USB interface	-
	Win7/Win8	/Win10(Plug and play)	-
System Support	Android/Linux (-	
Power Supply	USB(400mA)	-	
Color Numbers		-	
Backlight Type		White LED	-

2. EXTERNAL DIMENSIONS



3. ABSOLUTE MAXIMUM RATINGS

Parameter of absolute maximum ratings	Symbol	Min	Max	Unit
Operating temperature	Тор	-10	60	${\mathscr C}$
Storage temperature	Tst	-20	70	$^{\circ}C$
Humidity	RH	-	90%(Max 60°C)	RH

Note: Absolute maximum ratings means the product can withstand short-term, not more than 120 hours. If the product is a long time to withstand these conditions, the life time would be shorter.

4、ELECTRICAL CHARACTERISTICS(DC CHARACTERISTICS)

Parameter of DC	Symbol	Min.	Тур.	Max.	Unit	
characteristics	Symbol	IVIIII.	Typ.	max.	Onn	
PCB operating voltage	VCC5V	9V	-	12V	V	
LCD I/O operating voltage	VDD	2.3	2.5	2.7	V	
Input voltage 'H' level	VIH	0.8*VDD	-	VDD	V	
Input voltage 'L' level	VIL	VSS	-	0.2*VDD	V	
Output voltage 'H' level	VOH	VDD-0.4	-	VDD	V	
Output voltage 'L' level	VOL	VSS	-	VSS+0.4	V	

WKS

5, CTP CHARACTERISTICS

Item of CTP characteristics	Specification	Unit	Remark
Panel Type	Glass Cover + Glass Sensor	-	-
Resolution	1280 × 800	pixel	-
Surface Hardness	6H	-	-
Transparency	≥86%	-	-
Interface Type	USB interface	-	-
Support Points	10(MAX)	-	-
Sampling Rate	20~100	Hz	-
Supply voltage	3.3	V	-

6, ELECTRO-OPTICAL CHARACTERISTICS

Item of electro-optical characteristics		Symbol	Condition	Min.	Тур.	Max.	Unit	Remark	Note
Response	time	Tr+Tf	0.0	-	25	50	ms	FIG 1.	4
Contrast I	Ratio	CR	θ=0 ∅=0 Ta=25°C	-	600	-	-	FIG 2.	1
Luminance un	iformity	<i>δWHITE</i>		-	80	-	%	FIG 2.	3
Surface Lum	inance	Lv		-	300	_	cd/m2	FIG 2.	2
CIE(x, y)		White x	$\theta = 0$	0.27	0.31	0.35		FIG 2.	
chromaticity	White	White y	Ø=0 Ta=25°C	0.28	0.32	0.36	-		5
	Ø=90(1	2 o'clock)		75	85	-	deg		
Viewing	Ø=270((6 o'clock)	CD > 10	75	85	_	deg	EIC 2	_
angle range	Ø=0(3 d	o'clock)	CR ≥ 10	75	85	-	deg	FIG 3.	6
	Ø=180 ₀	(9 o'clock)		75	85	-	deg		
NTSC ratio		-	-	-	50	-	%	-	-

Note 1. Contrast Ratio(CR) is defined mathematically by the following formula. For more information see FIG 2.:

 $Contrast\ Ratio(CR) = \frac{Average\ Surface\ Luminance\ with\ all\ white\ pixels(P1,P2,P3,P4,P5,P6,P7,P8,P9)}{Average\ Surface\ Luminance\ with\ all\ black\ pixels(P1,P2,P3,P4,P5,P6,P7,P8,P9)}$

Note 2. Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information see FIG 2.

Lv=Average Surface Luminance with all white pixels (P1,P2,P3,P4,P5,P6,P7,P8,P9)

Note 3. The uniformity in surface luminance (SWHITE) is determined by measuring

luminance at each test position 1 through 9, and then dividing the maximum luminance of

9points luminance by minimum luminance of 9 points luminance. For more information see

FIG 2.

 $\delta \text{WHITE} = \frac{\textit{Minimum Surface Luminance with all white pixels (P1, P2, P3, P4, P5, P6, P7, P8, P9)}}{\textit{Maximum Surface Luminance with all white pixels (P1, P2, P3, P4, P5, P6, P7, P8, P9)}}$

Note 4. The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (T_{ON}) is the time between photo detector output intensity changed from 90% to 10%. And fall time (T_{OFF}) is the time between photo detector output intensity changed from 10% to 90%. For more information see FIG 1.

Note 5. CIE (x, y) chromaticity, The x,y value is determined by screen active area position 5. For more information see FIG 2.

Note 6. Viewing angle is the angle at which the contrast ratio is greater than a specific value. For TFT module, the specific value of contrast ratio is 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.

Note 7. For Viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope. Series Instruments. For contrast ratio, Surface Luminance, Luminance uniformity and CIE, the testing data is base on BM-7 photo detector.

Note 8. For TN type TFT transmissive module, Gray scale reverse occurs in the direction of panel viewing angle.

FIG.1. The definition of Response Time

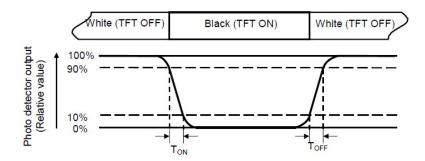


FIG.2. Measuring method for Contrast ratio, surface luminance, Luminance uniformity,

CIE(x, y) chromaticity

A: H/6;B: V/6;

H,V: Active Area(AA) size

Measurement instrument: BM-7; Light spot size=5mm, 350mm distance from the LCD surface to detector lens.

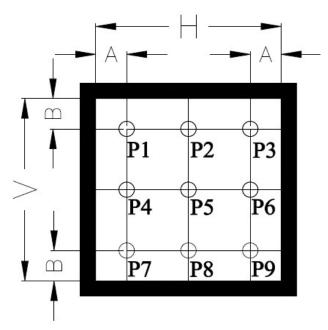
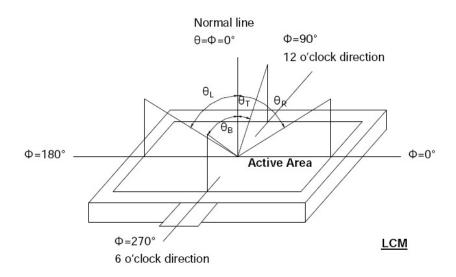


FIG.3. The definition of viewing angle



7. INTERFACE DESCRIPTION

A, HDMI Interface Description

	NO.	Symbol	DESCRIPTION
	1	TMDS Data2+	Positive side of channel 2 TMDS low-voltage signal differential input pair
MICRO HD	MI 0 2	TMDS Data2 Shield	Ground
	3	TMDS Data2-	Negative side of channel 2 TMDS low-voltage signal differential input pair
	4	TMDS Data1+	Positive side of channel 1 TMDS low-voltage signal differential input pair
	5	TMDS Data1 Shield	Ground
	6	TMDS Data1-	Negative side of channel 1 TMDS low-voltage signal differential input pair
	7	TMDS Data0+	Positive side of channel 0 TMDS low-voltage signal differential input pair
	8	TMDS Data0 Shield	Ground
	9	TMDS Data0-	Negative side of channel 0 TMDS low-voltage signal differential input pair
	10	TMDS Clock+	Positive side of reference clock. TMDS low-voltage signal differential input pair
	11	TMDS Clock Shield	Ground
	12	TMDS Clock-	Negative side of reference clock. TMDS low-voltage signal differential input pair
	13	CEC	No Connection
	14	Reserved(N.C.)	No Connection
	15	SCL	DDC SCL
	16	SDA	DDC SDA
	17	DDC/CEC Ground	Ground
	18	+5V Power	+5V Power
	19	Hot Plug Detect	Hot Plug Detect

B. USB TOUCH Interface Description

NO.	Symbol	DESCRIPTION
1	VUSB	USB Power CC P
2	D-	USB Data-
3	D+	USB Data+
4	NC	No connection
5	GND	Power Ground

C. External POWER Interface Description

NO.	Symbol	DESCRIPTION
1	9V~12V	External power input(9V~12V)
2	GND	Power Ground
3	PWM(EN)	Backlight On/Off Control Input. A high input at EN turns on the converter, and a low input turns it off. When not used, connect EN to the input source for automatic startup. The EN pin cannot be left floating. To use PWM dimming, apply a 200Hz to 1KHz square wave signal with amplitude greater than 1.5V to this pin.
4	GND	Power Ground

Parameters	Symbol	Condition	Min	Тур	Max	Units
Enable						
EN Threshold		V _{EN} Rising, V _{IN} = 5V	1.0	1.35	1.6	V
EN Threshold		V _{EN} Rising, V _{IN} = 2.5V	0.8			V
EN Hysteresis				90		m∨
EN Input Bias Current		V _{EN} = 0V, 5V			1	μΑ

Application Note:

If the customer does not have additional GPIO to control the backlight, then must be connect a resistance to R41 on the PCB as follows:



8. LCD TIMING

D	G1 . 1		17:4		
Parameter	Symbol	Min.	Тур.	Max.	Unit
DCLK frequency@ Frame rate=60Hz	DCLK	68.9	71.1	73.4	MHz
Horizontal display area	thd		1280		DCLK
1 Horizontal Line	th	1340 1440 1470			DCLK
HSYNC pulse width	thpw	-	10	-	DCLK
HSYNC Back Porch(Blanking)	thb	-	80	-	DCLK
HSYNC Front Porch	thfp	-	70	-	DCLK
Vertical display area	tvd		800	Н	
VSYNC period time	tv 815 823 833		833	Н	
VSYNC pulse width	tvpw	-	3	-	Н
VSYNC Back Porch(Blanking)	tvb	-	10	-	Н
VSYNC Front Porch	tvfp	-	10	-	Н

9 RELIABILITY TEST CONDITIONS

No.	Test Item	Test Condition
1	High Temperature Storage	70°C/120 hours
2	Low Temperature Storage	-20°C/120 hours
3	High Temperature Operating	60°C/120 hours
4	Low Temperature Operating	-10°C/120 hours
5	Temperature Cycle Storage	-10°C(30min.)~25(5min.)~60°C(30min.)×10cycles

A. Inspection after test:

Inspection after 2~4 hours storage at room temperature, the sample shall be free from defects:

- ➤ Air bubble in the LCD;
- ➤ Sealleak;
- ➤ Non-display;
- Missing segments;
- ➤ Glass crack;
- > Current is twice higher than initial value.

B, Remark:

- The test samples should be applied to only one test item.
- ➤ Sample size for each test item is 5~10pcs.
- ➤ Failure Judgment Criterion: Basic Specification, Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.

10. INSPECTION CRITERION

This specification is made to be used as the standard of acceptance/rejection criteria for TFT-LCD/IPS TFT-LCD module product, and this specification is applicable only in the case that the size of module equal to or exceed than 4.3 inch.

10.1 Sample plan

Sampling plan according to GB/T2828.1-2003/ISO 2859-1: 1999 and ANSI/ASQC Z1.4-1993,normal level 2 and based on:

Major defect: AQL 0.65

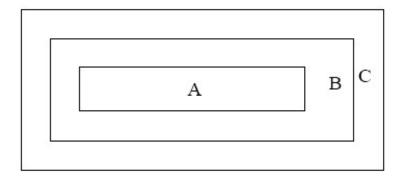
Minor defect: AQL 1.5

10.2 Inspection condition

Viewing distance for cosmetic inspection is about 30cm with bare eyes, and under an environment of $20\sim40W$ light intensity, all directions for inspecting the sample should be within 45 °against perpendicular line. (Normal temperature $20\sim25$ °C and normal humidity 60 $\pm15\%RH$)

10.3 Definition of Inspection Item.

A Definition of inspection zone in LCD.



Zone A: character/Digit area

WKS

Zone B: viewing area except Zone A (Zone A + Zone B=minimum Viewing area)

Zone C: Outside viewing area (invisible area after assembly in customer's product)

Fig. 1 Inspection zones in an LCD

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product.

B. Definition of some visual defect

Bright dot	Because of losing all or part function, bad pixel dots appear bright and the					
	size is more than 50% of one dot in which LCD panel is displaying under					
	black pattern.					
Dark dot	Dots appear dark and unchanged in size in which LCD panel is displaying					
	under pure red, green, blue picture, or pure whiter picture.					

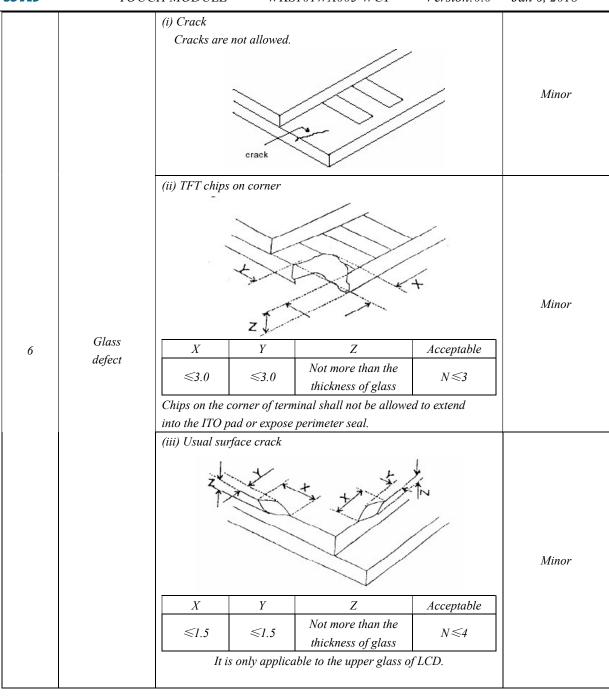
10.4 Major Defect

Item No.	Items to be	Inspection standard	Classification of defects
1	Functional defects	 No display Display abnormally Missing vertical, horizontal segment Short circuit Excess power consumption Backlight no lighting, flickering and abnormal lighting 	major
2	Missing	Missing component	
3	Outline dimension	Overall outline dimension beyond the drawing is not allowed	

10.5, Minor Defect

Item No.	Items to be		Classification of defects						
		Zone		Acceptable Qty A+B					
			4.	3" ~	7~10.1	>10.1"	С		
		Bright pixel de	ot	1	2	3			
	Bright dot	Dark pixel do	t	4	4	4	5		
1	/dark dot	2bright dots adj	acent	0	0	0	cce	Minor	
	defect	2dark dots adja	cent	0	0	0	Acceptable		
		Total bright and dots	dark dark	5	6	7	ole		
		Pixel dots' function	Note: Minimum distance between defective dots is more than 5mm; Pixel dots' function is normal, but bright dots caused by foreign material and other reasons are judged by the dot defect of 5.2.						
		Zone Acceptable Qty							
			A+B						
	Dot defect	Size(mm)	4.3"~7"	4.3"~7" 7~10.1" >10.1"		С			
		<i>Φ</i> ≤0.2	Acceptab	le Acc	eptable	Acceptable	Acc		
2		\bigvee_{x}^{y}	$0.2 < \Phi \le 0.5$	4		5	6	Acceptable 0	Minor
2			Φ>0.5	0		0	0		
		Note: 1. Minimum distance 2. The quantity of december 1.					m;		
	Linear defect	Zone		Ac	cceptable	Qty			
		Size (mm)	e (mm)						
2		Length Width	4.3"~7"	7	~10.1"	>10.1"	с	<i>M</i> :	
3		defect	Ignore W≤0.05	Acceptab	le Aco	eptable	Acceptable	Ac	Minor
			$ 1 L \leq 5 0 $		4		5	6	Acceptable
		L>5.0 W>0.1	0		0	0	le		

1000	II MODC	LL	WKS101W.	1003-WC1	version	1.0.0	Jan 6, 2018
Polarizer defect	5.4.1 Pole (i) Shiftind dimension (ii) Incomplete allowed. $5.4.2$ Dirth whice $5.4.3$ Pole $5.4.3$ Pole $6.2 < 6.4$ Dirth whice $6.2 < 6.4$ Dirth which which is $6.2 < 6.4$ Dirth which	prizer Position in the property of the polarizer of the	tion on should not ering of the vi ter iped easily sho te Air bubble 4.3"~7" Acceptable 4 0 ratch scratch can be condition, ju special angle 4.3"~7" Acceptable	exceed the glo ewing area du ould be accept A+B $7 \sim 10.1$ " Acceptable 5 0 be seen after udge by the l be seen only e, judge by th Acceptable $A+B$ $7 \sim 10.1$ " Acceptable $5 \sim 10.1$ " Acceptable $5 \sim 10.1$ "	ass outline te to shifting is table. Qty >10.1" Acceptable 6 0 cover asseminear defect on non-oper te following: Qty >10.1" Acceptable 6	C Acceptable	Minor
MURA White/Black dot (MURA)	Using	Using 3% ND filter, it's NG if it can be seen in R,G,B picture. $Visible \ under: \ ND3\%; \ D \leq 0.15mm, \ Acceptable; \\ 0.15mm < D \leq 0.5mm, \ N \leq 4; \ D > 0.5mm, \ Not \ allowable.$					Minor
	Polarizer defect MURA White/Black	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	(i) Shifting in position dimension. (ii) Incomplete cover allowed. 5.4.2 Dirt on polarized Dirt which can be we seem to see the seem to see	5.4.1 Polarizer Position (i) Shifting in position should not dimension. (ii) Incomplete covering of the viallowed. 5.4.2 Dirt on polarizer Dirt which can be wiped easily shown that the standard properties of the polarizer Dent & Air bubble. Zone Size(mm) 4.3" ~7" Φ ≤ 0.2 Acceptable 0.2 < Φ ≤ 0.5 4 Polarizer defect 5.4.4 Polarizer scratch (i) If the polarizer scratch can be or in the operating condition, jutic ii) If the polarizer scratch can condition or some special angle. Zone Size (mm) Length Width 4.3" ~7" Ignore W ≤ 0.05 Acceptable 1.0 < 1 0.05 < 4 0.05	S.4.1 Polarizer Position (i) Shifting in position should not exceed the gle dimension. (ii) Incomplete covering of the viewing area diallowed. S.4.2 Dirt on polarizer Dirt which can be wiped easily should be acception and the state of the polarizer Dent & Air bubble. Zone	5.4.1 Polarizer Position (i) Shifting in position should not exceed the glass outline dimension. (ii) Incomplete covering of the viewing area due to shifting is allowed. 5.4.2 Dirt on polarizer Dirt which can be wiped easily should be acceptable. 5.4.3 Polarizer Dent & Air bubble Zone Acceptable Oty A+B Size(mm) 4.3"~7" 7~10.1" >10.1" Φ ≤ 0.2 Acceptable Acceptable Acceptable 0.2 < Φ ≤ 0.5 4 5 6 Φ > 0.5 0 0 0 5.4.4 Polarizer scratch (i) If the polarizer scratch can be seen after cover assemmor in the operating condition, judge by the linear defect (ii) If the polarizer scratch can be seen only in non-oper condition or some special angle, judge by the following: Zone Acceptable Qty Size (mm) A+B Length Width 4.3"~7" 7~10.1" >10.1" Ignore W≤0.05 Acceptable Acceptable Acceptable 1.0 < L 0.05 < ≤ 5.0 W≤0.20 4 5 6 L>5.0 W≥0.20 4 5 6 L>5.0 W≥0.20 0 0 0 MURA Using 3% ND filter, it's NG if it can be seen in R,G,B pictory White/Black Visible under: ND3%: D ≤0.15mm, Acceptable:	S.4.1 Polarizer Position (i) Shifting in position should not exceed the glass outline dimension. (ii) Incomplete covering of the viewing area due to shifting is not allowed. 5.4.2 Dirt on polarizer Dirt which can be wiped easily should be acceptable. 5.4.3 Polarizer Dent & Air bubble Zone



10.6 Module Cosmetic Criteria

Item No.	Items to be inspected	Inspection Standard	Classification of defects
1	Difference in Spec.	Not allowable	Major
2	Pattern peeling	No substrate pattern peeling and floating	Major
	Soldering defects	No soldering missing	Major
3		No soldering bridge	Major
		No cold soldering	Minor
4	Resist flaw on PCB	Visible copper foil (Φ 0.5 mm or more) on substrate pattern is not allowed	Minor
5	FPC gold finger	No dirt, breaking, oxidation lead to black	Major
6	Backlight plastic frame	No deformation, crack, breaking, backlight positioning column breaking, obvious nick.	Minor
7	Marking printing effect	No dark marking, incomplete, deformation lead to unable to judge	Minor
8	Accretion of metallic Foreign matter	No accretion of metallic foreign matter (Not exceed $\Phi 0.2mm$)	Minor
9	Stain	No stain to spoil cosmetic badly	Minor
10	Plate discoloring	No plate fading, rusting and discoloring	Minor
	1. Lead parts	a. Soldering side of PCB Solder to form a 'Filet' all around the lead. Solder should not hide the lead form perfectly.	Minor
		b. Components side(In case of 'Through Hole PCB') Solder to reach the Components side of PCB.	Minor
11	2. Flat packages	Either 'Toe'(A) or 'Seal'(B)of the lead to be covered by "Filet". Lead form to be assume over Solder.	Minor
	3. Chips	(3/2) H ≥h ≥(1/2) H \$\hat{\hat{h}} \hat{\hat{H}}\$	Minor
	4. Solder ball/Solder splash	a. The spacing between solder ball and the conductor or solder pad $h \ge 0.13$ mm. The diameter of solder ball $d \le 0.15$ mm.	Minor
		b. The quantity of solder balls or solder splashes isn't beyond 5 in 600 mm2.	Minor
		c. Solder balls/Solder splashes do not violate minimum electrical clearance.	Major

11, PRODUCT PHOTOS

PRODUCT



